

#### OEG Miniature Relay PCF

TE Internal #: 1744128-1 Connector Contact, Pin, Wire-to-Board, Tin, Bag & Box, Printed Circuit Board, 25 A, Power, Board Mount, OEG Miniature Relay PCF View on TE.com >



Connectors > PCB Connectors > Wire-to-Board Connectors > Wire-to-Board Connector Contacts



Contact Type: Pin

Connector System: Wire-to-Board

Contact Mating Area Plating Material: Tin

Packaging Method: Bag & Box

Connector & Contact Terminates To: Printed Circuit Board

# Features

#### Product Type Features

Connector & Contact Terminates To	Printed Circuit Board
Contact Features	
Contact Type	Pin
Contact Mating Area Plating Material	Tin
Contact Current Rating (Max)	25 A
Termination Features	
Rectangular Termination Post & Tail Thickness	.81 mm[.031 in]
Rectangular Termination Post & Tail Width	1.27 mm[.05 in]
Mechanical Attachment	
Connector Mounting Type	Board Mount
Usage Conditions	
Operating Temperature Range	-40 – 125 °C[-40 – 257 °F]
Operation/Application	

**C** For support call+1 800 522 6752

## 1744128-1

Connector Contact, Pin, Wire-to-Board, Tin, Bag & Box, Printed Circuit Board, 25 A, Power, Board Mount, OEG Miniature Relay PCF



Circuit Application	Power
Packaging Features	
Packaging Method	Bag & Box
<b>Product Compliance</b> For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not applicable for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# **Compatible Parts**



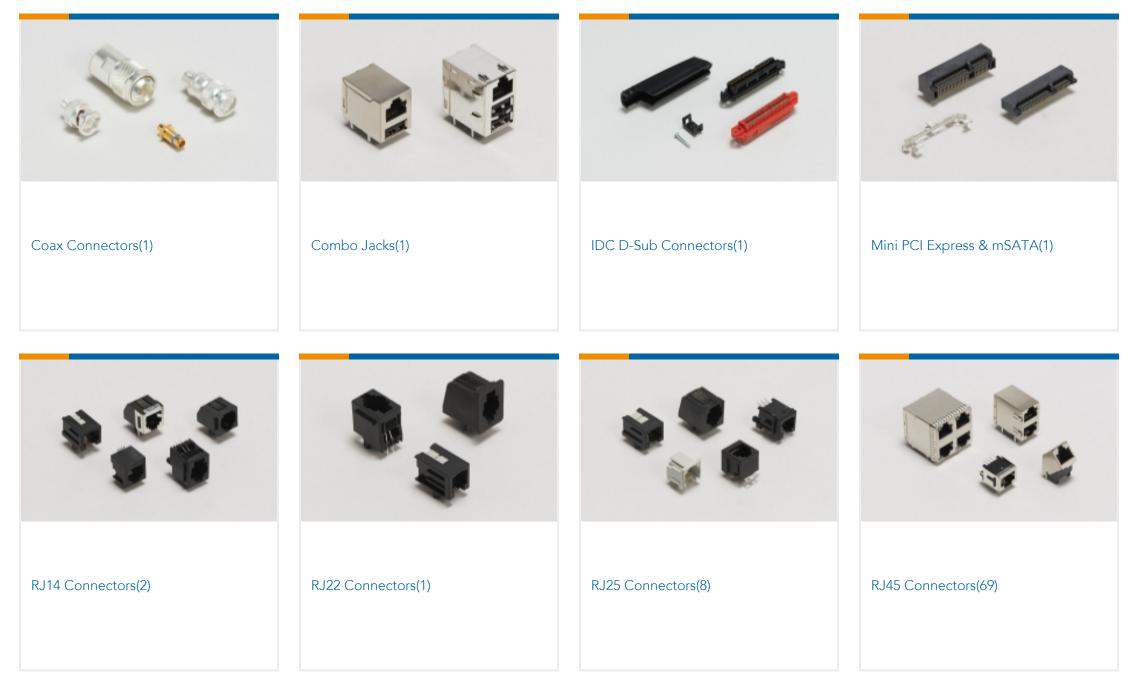
Also in the Series | OEG Miniature Relay PCF

**C** For support call+1 800 522 6752

### 1744128-1

Connector Contact, Pin, Wire-to-Board, Tin, Bag & Box, Printed Circuit Board, 25 A, Power, Board Mount, OEG Miniature Relay PCF







Wire-to-Board Connector Contacts(1)

# Customers Also Bought





# Documents

**C** For support call+1 800 522 6752

## 1744128-1

Connector Contact, Pin, Wire-to-Board, Tin, Bag & Box, Printed Circuit Board, 25 A, Power, Board Mount, OEG Miniature Relay PCF



# Product Drawings PCB CONTACT, CU/AG, STRAIGHT, PLA

English

**CAD** Files

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_1744128-1\_A\_c-1744128-1-a.2d\_dxf.zip

English

Customer View Model

ENG\_CVM\_CVM\_1744128-1\_A\_c-1744128-1-a.3d\_igs.zip

English

Customer View Model

ENG\_CVM\_CVM\_1744128-1\_A\_c-1744128-1-a.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the Terms and Conditions of use.

**Product Specifications** 

**Application Specification** 

English

**Application Specification** 

English